



**THE DATASHEET OF
AD7989-5BRMZ**



FEATURES

Low power dissipation

AD7989-1

400 μ W at 100 kSPS typical (VDD only)

700 μ W at 100 kSPS typical (total)

AD7989-5

2 mW at 500 kSPS typical (VDD only)

3.5 mW at 500 kSPS typical (total)

18-bit resolution with no missing codes

Throughput

AD7989-1

100 kSPS

AD7989-5

500 kSPS

INL: ± 1 LSB typical, 2 LSB maximum

SNR: 98 dB at 1 kHz, $V_{REF} = 5$ V typical

SINAD: 97 dB at 1 kHz typical

THD: -120 dB at 10 kHz typical

Dynamic range: 99 dB at $V_{REF} = 5$ V typical

True differential analog input voltage range: $\pm V_{REF}$

0 V to V_{REF} with V_{REF} between 2.4 V and 5.1 V

No pipeline delay

Single-supply 2.5 V operation with 1.8 V, 2.5 V, 3 V, and 5 V logic interface

Proprietary serial interface SPI-/QSPI™-/MICROWIRE™-/DSP-compatible¹

Ability to daisy-chain multiple ADCs

10-lead MSOP and 3 mm \times 3 mm 10-Lead LFCSP

APPLICATIONS

Battery-powered equipment

Data acquisition systems

Medical instruments

Seismic data acquisition systems

GENERAL DESCRIPTION

The AD7989-1/AD7989-5 are 18-bit, successive approximation, analog-to-digital converters (ADCs) that operate from a single power supply, VDD. The AD7989-1/AD7989-5 contain a low power, high speed, 18-bit sampling ADC and a versatile serial interface port. On the CNV rising edge, the AD7989-1/AD7989-5 sample the voltage difference between the IN+ and IN– pins. The voltages on these pins typically swing in opposite phases between 0 V and V_{REF} . The reference voltage, V_{REF} , is applied externally and can be set independent of the supply voltage, VDD. Its power scales linearly with throughput.

The AD7989-1/AD7989-5 are serial peripheral interface (SPI)-compatible, which features the ability, using the SDI/CS input, to daisy-chain several ADCs on a single 3-wire bus. The AD7989-1/AD7989-5 are compatible with 1.8 V, 2.5 V, 3 V, and 5 V logic, using the separate VIO supply.

The AD7989-1/AD7989-5 are available in a 10-lead MSOP or a 10-lead LFCSP with operation specified from -40°C to $+85^{\circ}\text{C}$.

Table 1. MSOP and LFCSP 14-/16-/18-Bit PulSAR® ADCs

Bits	100 kSPS	250 kSPS	400 kSPS to 500 kSPS	≥ 1000 kSPS
18 ¹	AD7989-1 ²	AD7691 ²	AD7690 ² AD7989-5 ²	AD7982 ² AD7984 ²
16 ¹	AD7684	AD7687 ²	AD7688 ² AD7693 ² AD7916 ²	AD7915 ²
16 ³	AD7680 AD7683 AD7988-1 ²	AD7685 ² AD7694	AD7686 ² AD7988-5 ²	AD7980 ² AD7983 ²
14 ³	AD7940	AD7942 ²	AD7946 ²	

¹ True differential.

² Pin for pin compatible.

³ Pseudo differential.

TYPICAL APPLICATIONS CIRCUIT

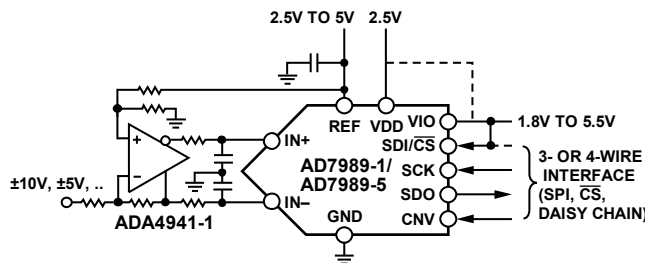


Figure 1.

¹ Protected by U.S. Patent 6,703,961.

Rev. B

Document Feedback

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REVISION HISTORY

1/2017—Rev. A to Rev. B

Change to Table 1	1
Changed VIO = 2.3 V to 5.5 V to VIO = 1.71 V to 5.5 V.....	3
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7/2014—Rev. 0 to Rev. A

Changes to Features Section	1
Changes to Table 1.....	1
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1/2014—Revision 0: Initial Version

SPECIFICATIONS

VDD = 2.5 V, VIO = 1.71 V to 5.5 V, VREF = 5 V, TA = -40°C to +85°C, unless otherwise noted.

Table 2.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
RESOLUTION		18			Bits
ANALOG INPUT					
Voltage Range	IN+ – IN–	–VREF		+VREF	V
Absolute Input Voltage	IN+ and IN–	–0.1		VREF + 0.1	V
Common-Mode Input Range	IN+ and IN–	VREF × 0.475	VREF × 0.5	VREF × 0.525	V
Analog Input Common Mode Rejection Ratio (CMRR)	fIN = 450 kHz		67		dB
Leakage Current at 25°C	Acquisition phase		200		nA
Input Impedance		See the Analog Inputs section			
ACCURACY					
No Missing Codes		18			Bits
Differential Nonlinearity Error (DNL)		–0.85	±0.5	+1.5	LSB
Integral Nonlinearity Error (INL)		–2	±1	+2	LSB
Transition Noise	VREF = 5 V		1.05		LSB ¹
Gain Error, TMIN to TMAX ²		–0.023	+0.004	+0.023	% of FS
Gain Error Temperature Drift			±1		ppm/°C
Zero Error, TMIN to TMAX ²			±100	+700	μV
Zero Temperature Drift			0.5		ppm/°C
Power Supply Rejection Ratio (PSRR)	VDD = 2.5 V ± 5%		90		dB
THROUGHPUT					
AD7989-1 Conversion Rate		0		100	kSPS
AD7989-5 Conversion Rate		0		500	kSPS
Transient Response	Full-scale step			400	ns
AC ACCURACY					
Dynamic Range	VREF = 5 V	97	99		dB ³
	VREF = 2.5 V		93		dB ³
Oversampled Dynamic Range ⁴	fO = 1 kSPS		126		dB ³
Signal-to-Noise Ratio (SNR)	fIN = 1 kHz, VREF = 5 V	95.5	98		dB ³
	fIN = 1 kHz, VREF = 2.5 V		92.5		dB ³
Spurious-Free Dynamic Range (SFDR)	fIN = 10 kHz		–115		dB ³
Total Harmonic Distortion (THD)	fIN = 10 kHz		–120		dB ³
Signal-to-Noise-and-Distortion Ratio (SINAD)	fIN = 1 kHz, VREF = 5 V		97		dB ³

¹ LSB means least significant bit. With the ±5 V input range, 1 LSB is 38.15 μV.

² See the Terminology section. These specifications include full temperature range variation but not the error contribution from the external reference.

³ All specifications expressed in decibels are referred to a full-scale input range (FSR) and tested with an input signal at 0.5 dB below full scale, unless otherwise specified.

⁴ Dynamic range is obtained by oversampling the ADC running at a throughput, fs, of 500 kSPS followed by postdigital filtering with an output word rate of fO.

⁵ Tested fully in production at fIN = 1 kHz.

VDD = 2.5 V, VIO = 1.71 V to 5.5 V, VREF = 5 V, TA = -40°C to +85°C, unless otherwise noted.

Table 3.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
REFERENCE					
Voltage Range		2.4		5.1	V
Load Current	VREF = 5 V		250		μA
SAMPLING DYNAMICS					
-3 dB Input Bandwidth			10		MHz
Aperture Delay	VDD = 2.5 V		2		ns
DIGITAL INPUTS					
Logic Levels					
VIL	VIO > 3 V	-0.3		+0.3 × VIO	V
	VIO ≤ 3 V	-0.3		+0.1 × VIO	V
VIH	VIO > 3 V	0.7 × VIO		VIO + 0.3	V
	VIO ≤ 3 V	0.9 × VIO		VIO + 0.3	V
IIL		-1		+1	μA
IIH		-1		+1	μA
DIGITAL OUTPUTS					
Data Format		Serial, 18 bits, twos complement			
Pipeline Delay		Conversion results available immediately after completed conversion			
VOL	ISINK = +500 μA			0.4	V
VOH	ISOURCE = -500 μA	VIO - 0.3			V
POWER SUPPLIES					
VDD		2.375	2.5	2.625	V
VIO		1.71		5.5	V
Standby Current ^{1,2}	VDD and VIO = 2.5 V, 25°C		0.35		μA
AD7989-1 Power Dissipation	VDD = 2.625 V, VREF = 5 V, VIO = 3 V				
Total	10 kSPS throughput		70	86	μW
	100 kSPS throughput		700	860	μW
VDD Only			400		μW
REF Only			170		μW
VIO Only			130		μW
AD7989-5 Power Dissipation	VDD = 2.625 V, VREF = 5 V, VIO = 3 V				
Total	500 kSPS throughput		3.5	4.3	mW
VDD Only			2		mW
REF Only			0.85		mW
VIO Only			0.65		mW
Energy per Conversion			7.0		nJ/sample
TEMPERATURE RANGE					
Specified Performance	TMIN to TMAX	-40		+85	°C

¹ With all digital inputs forced to VIO or ground as required.

² During acquisition phase.

TIMING SPECIFICATIONSVDD = 2.37 V to 2.63 V, VIO = 2.3 V to 5.5 V, T_A = -40°C to +85°C, unless otherwise noted.¹**Table 4.**

Parameter	Symbol	Min	Typ	Max	Unit
THROUGHPUT RATE					
AD7989-1				100	kSPS
AD7989-5				500	kSPS
CONVERSION AND ACQUISITION TIMES					
Conversion Time: CNV Rising Edge to Data Available	t _{CONV}				
AD7989-1				9500	ns
AD7989-5				1600	ns
Acquisition Time	t _{ACQ}				
AD7989-1		500			ns
AD7989-5		400			ns
Time Between Conversions	t _{CYC}				
AD7989-1		10			μs
AD7989-5		2			μs
CNV PULSE WIDTH (CS MODE)	t _{CNVH}	500			ns
SCK					
SCK Period (CS Mode)	t _{SCK}				
VIO Above 4.5 V		10.5			ns
VIO Above 3 V		12			ns
VIO Above 2.7 V		13			ns
VIO Above 2.3 V		15			ns
SCK Period (Chain Mode)	t _{SCK}				
VIO Above 4.5 V		11.5			ns
VIO Above 3 V		13			ns
VIO Above 2.7 V		14			ns
VIO Above 2.3 V		16			ns
SCK Low Time	t _{SCKL}	4.5			ns
SCK High Time	t _{SCKH}	4.5			ns
SCK Falling Edge to Data Remains Valid	t _{HSDO}	3			ns
SCK Falling Edge to Data Valid Delay	t _{DSDO}				
VIO Above 4.5 V				9.5	ns
VIO Above 3 V				11	ns
VIO Above 2.7 V				12	ns
VIO Above 2.3 V				14	ns
CS MODE					
CNV or SDI Low to SDO D17 MSB Valid	t _{EN}				
VIO Above 3 V				10	ns
VIO Above 2.3V				15	ns
CNV or SDI High or Last SCK Falling Edge to SDO High Impedance (CS Mode)	t _{DIS}			20	ns
SDI Valid Setup Time from CNV Rising Edge (CS Mode)	t _{SSDICNV}	5			ns
SDI Valid Hold Time from CNV Rising Edge (CS Mode)	t _{HSDICNV}	2			ns
CHAIN MODE					
SCK Valid Setup Time from CNV Rising Edge	t _{SSCKCNV}	5			ns
SCK Valid Hold Time from CNV Rising Edge	t _{HSCKCNV}	5			ns
SDI Valid Setup Time from SCK Falling Edge	t _{SSDISCK}	2			ns
SDI Valid Hold Time from SCK Falling Edge	t _{HSDISCK}	3			ns

¹ See Figure 2 and Figure 3 for load conditions.

VDD = 2.37 V to 2.63 V, VIO = 1.71 V to 2.3 V, -40°C to +85°C, unless otherwise stated.¹

Table 5.

Parameter	Symbol	Min	Typ	Max	Unit
THROUGHPUT RATE					
AD7989-1				100	kSPS
AD7989-5				500	kSPS
CONVERSION AND ACQUISITION TIMES					
Conversion Time: CNV Rising Edge to Data Available	t_{CONV}			9500	ns
AD7989-1				1500	ns
AD7989-5					
Acquisition Time	t_{ACQ}				
AD7989-1		500			ns
AD7989-5		400			ns
Time Between Conversions	t_{CYC}				
AD7989-1		10			μs
AD7989-5		2			μs
CNV PULSE WIDTH (CS MODE)	t_{CNVH}	500			ns
SCK					
SCK Period (CS Mode)	t_{SCK}	22			ns
SCK Period (Chain Mode)	t_{SCK}	23			ns
SCK Low Time	t_{SCKL}	6			ns
SCK High Time	t_{SCKH}	6			ns
SCK Falling Edge to Data Remains Valid	t_{HSDO}	3			ns
SCK Falling Edge to Data Valid Delay	t_{DSDO}		14	21	ns
CS MODE					
CNV or SDI Low to SDO D17 MSB Valid	t_{EN}		18	40	ns
CNV or SDI High or Last SCK Falling Edge to SDO High Impedance	t_{DIS}			20	ns
SDI Valid Setup Time from CNV Rising Edge	$t_{SSDICNV}$	5			ns
SDI Valid Hold Time from CNV Rising Edge	$t_{HSDICNV}$	10			ns
CHAIN MODE					
SCK Valid Setup Time from CNV Rising Edge	$t_{SSCKCNV}$	5			ns
SCK Valid Hold Time from CNV Rising Edge	$t_{HSCKCNV}$	5			ns
SDI Valid Setup Time from SCK Falling Edge	$t_{SSDISCK}$	2			ns
SDI Valid Hold Time from SCK Falling Edge	$t_{HSDISCK}$	3			ns

¹ See Figure 2 and Figure 3 for load conditions.

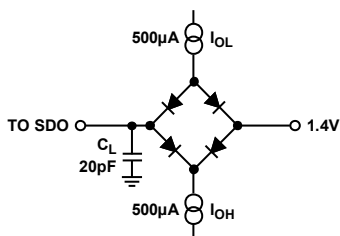
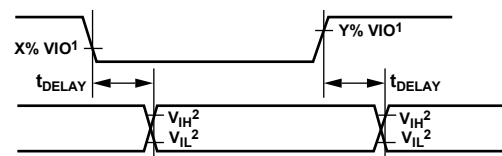


Figure 2. Load Circuit for Digital Interface Timing



¹FOR VIO ≤ 3.0V, X = 90 AND Y = 10; FOR VIO > 3.0V, X = 70 AND Y = 30.
²MINIMUM VIH AND MAXIMUM VIL USED. SEE DIGITAL INPUTS SPECIFICATIONS IN TABLE 3.

Figure 3. Voltage Levels for Timing

ABSOLUTE MAXIMUM RATINGS

Table 6.

Parameter	Rating
Analog Inputs	
IN+, IN– to GND ¹	–0.3 V to $V_{REF} + 0.3$ V or ± 130 mA
Supply Voltage	
REF, VIO to GND	–0.3 V to +6.0 V
VDD to GND	–0.3 V to +3.0 V
VDD to VIO	+3 V to –6 V
Digital Inputs to GND	–0.3 V to VIO + 0.3 V
Digital Output to GND	–0.3 V to VIO + 0.3 V
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
θ_{JA} Thermal Impedance	
10-Lead MSOP	200°C/W
10-Lead LFCSP	48.7°C/W
θ_{JC} Thermal Impedance	
10-Lead MSOP	44°C/W
10-Lead LFCSP	2.96°C/W
Reflow Soldering	JEDEC Standard (J-STD-020)

¹ See the Analog Inputs section for an explanation of IN+ and IN–.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

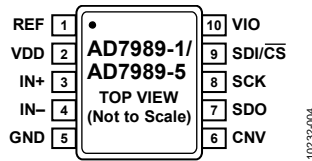
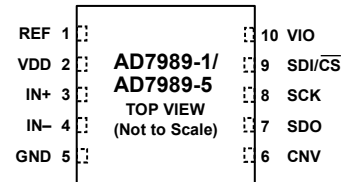


Figure 4. 10-Lead MSOP Pin Configuration



NOTES

- EXPOSED PAD. FOR THE LFCSP, THE EXPOSED PAD CAN BE CONNECTED TO GND. THIS CONNECTION IS NOT REQUIRED TO MEET THE ELECTRICAL PERFORMANCES.

Figure 5. 10-Lead LFCSP Pin Configuration

Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Type ¹	Description
1	REF	AI	Reference Input Voltage. The REF range is 2.4 V to 5.1 V. This pin is referred to the GND pin and must be decoupled closely to the GND pin with a 10 μ F capacitor.
2	VDD	P	Power Supply.
3	IN+	AI	Differential Positive Analog Input.
4	IN-	AI	Differential Negative Analog Input.
5	GND	P	Power Supply Ground.
6	CNV	DI	Conversion Input. This input has multiple functions. On its leading edge, it initiates the conversions and selects the interface mode of the device: chain mode or chip select ($\overline{\text{CS}}$) mode. In $\overline{\text{CS}}$ mode, the SDO pin is enabled when CNV is low. In chain mode, the data is read when CNV is high.
7	SDO	DO	Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
8	SCK	DI	Serial Data Clock Input. When the device is selected, the conversion result is shifted out by this clock.
9	SDI/ $\overline{\text{CS}}$	DI	Serial Data Input/Chip Select. This input has multiple functions. It selects the interface mode of the ADC as follows: Chain mode is selected if this pin is low during the CNV rising edge. In this mode, $\overline{\text{SDI/CS}}$ is a data input that daisy-chains the conversion results of two or more ADCs onto a single SDO line. The digital data level on $\overline{\text{SDI/CS}}$ is the output on SDO with a delay of 16 SCK cycles. $\overline{\text{CS}}$ mode is selected if $\overline{\text{SDI/CS}}$ is high during the CNV rising edge. In this mode, either $\overline{\text{SDI/CS}}$ or CNV can enable the serial output signals when low.
10	VIO	P	Input/Output Interface Digital Power. This pin is nominally at the same supply as the host interface (1.8 V, 2.5 V, 3 V, or 5 V).
	EPAD		Exposed Pad. For the LFCSP, the exposed pad can be connected to GND. This connection is not required to meet the electrical performances.

¹AI means analog input, DI means digital input, DO means digital output, and P means power.

TYPICAL PERFORMANCE CHARACTERISTICS

VDD = 2.5 V, VREF = 5.0 V, VIO = 3.3 V.

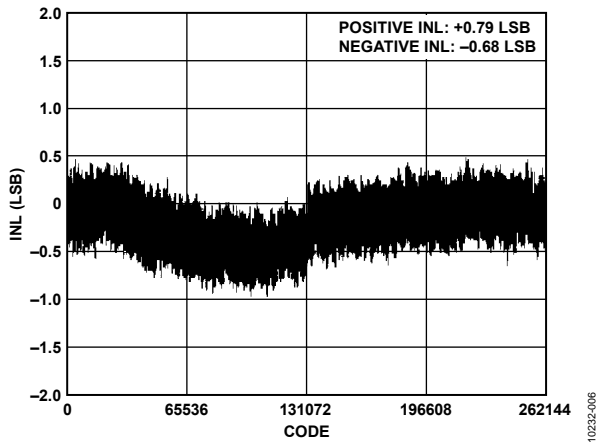


Figure 6. INL vs. Code

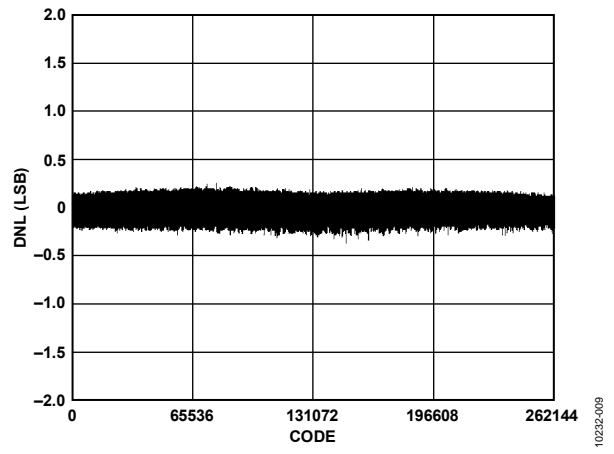


Figure 9. DNL vs. Code

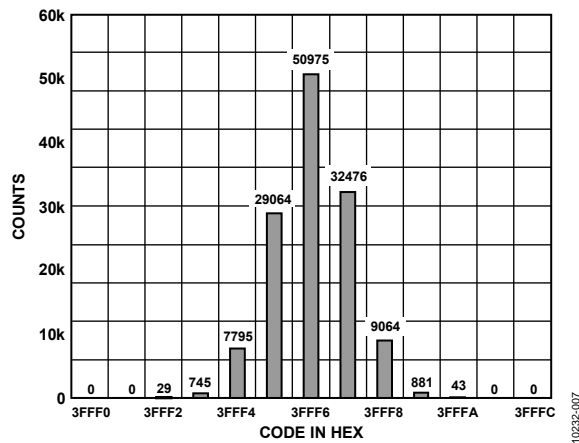


Figure 7. Histogram of a DC Input at the Code Center

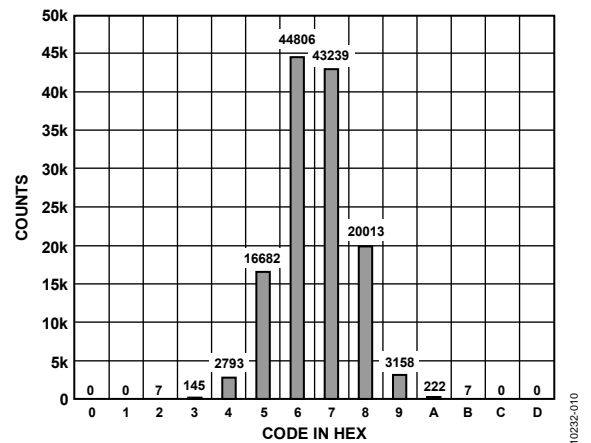


Figure 10. Histogram of a DC Input at the Code Transition

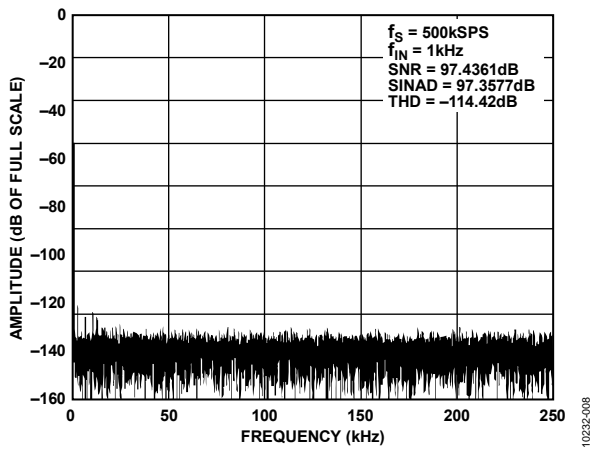


Figure 8. AD7989-5 Fast Fourier Transform (FFT) Plot

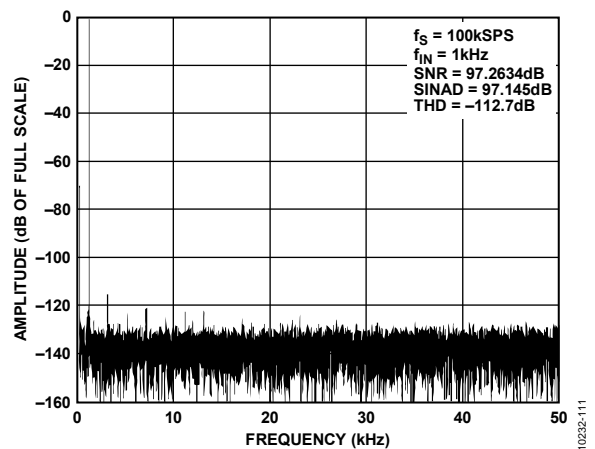


Figure 11. AD7989-1 FFT Plot

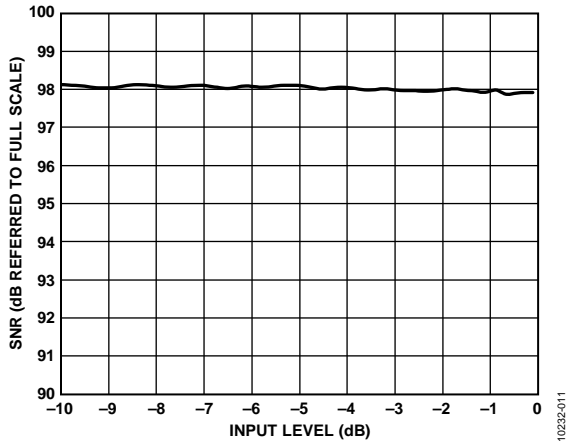


Figure 12. SNR vs. Input Level

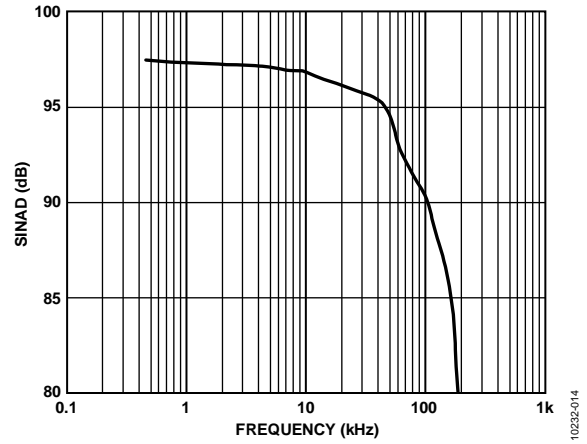


Figure 15. SINAD vs. Frequency

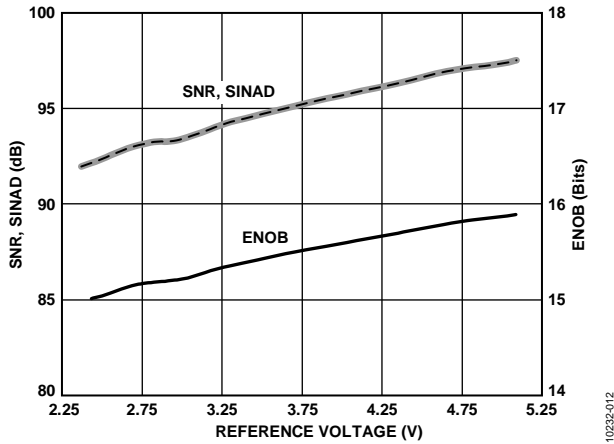


Figure 13. SNR, SINAD, and ENOB vs. Reference Voltage

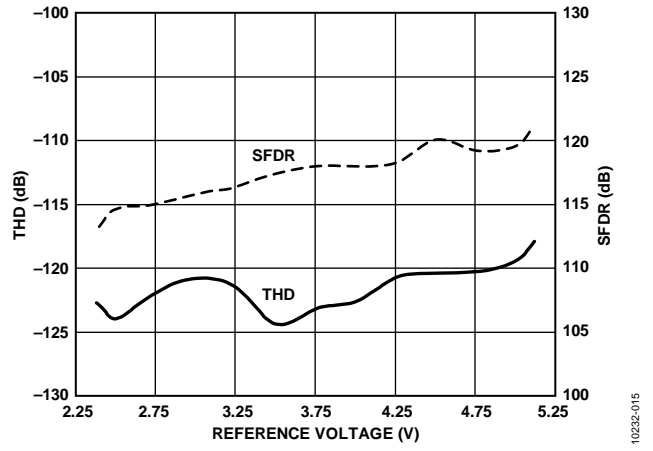


Figure 16. THD and SFDR vs. Reference Voltage

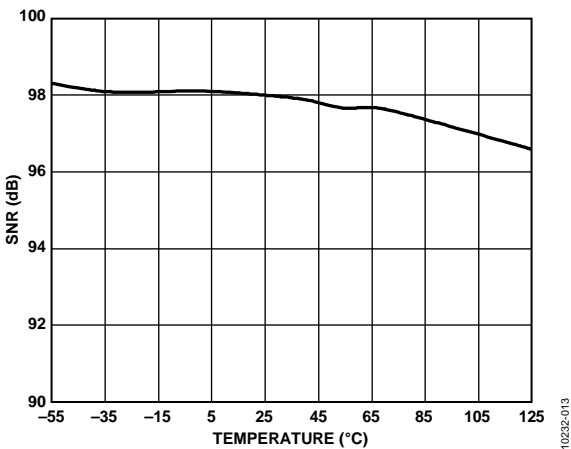


Figure 14. SNR vs. Temperature

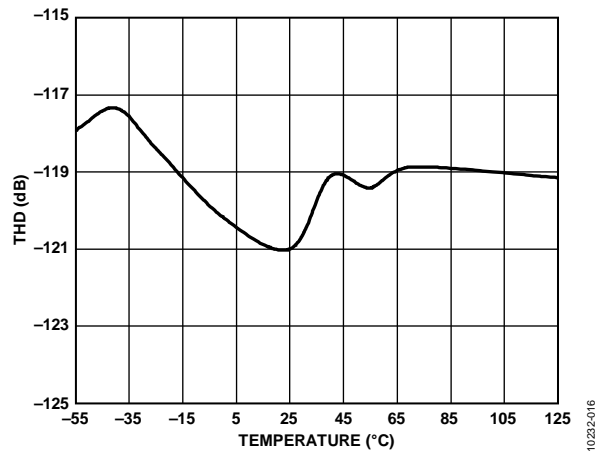


Figure 17. THD vs. Temperature

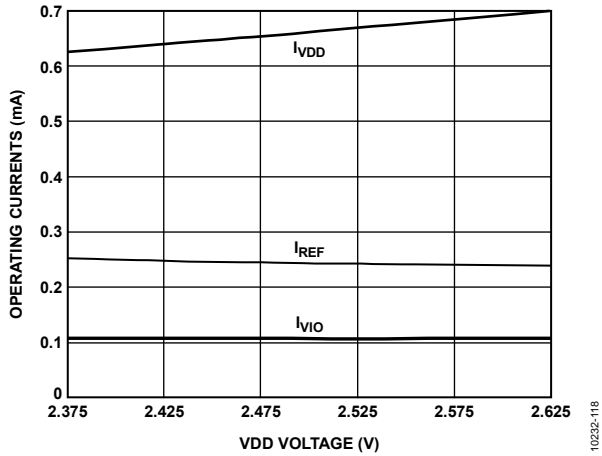


Figure 18. Operating Currents vs. VDD Voltage (AD7989-5)

10232-118

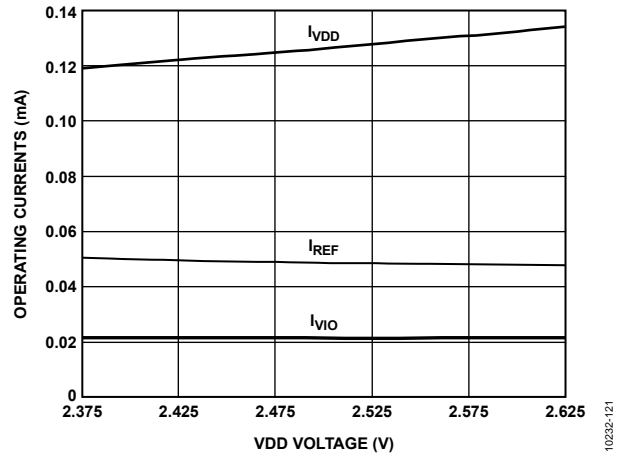


Figure 21. Operating Currents vs. VDD Voltage (AD7989-1)

10232-121

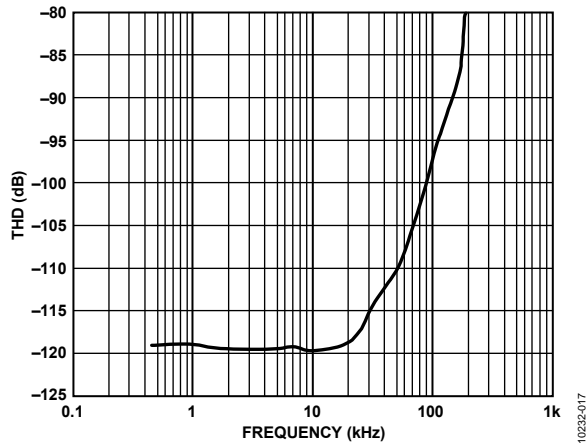


Figure 19. THD vs. Frequency

10232-017

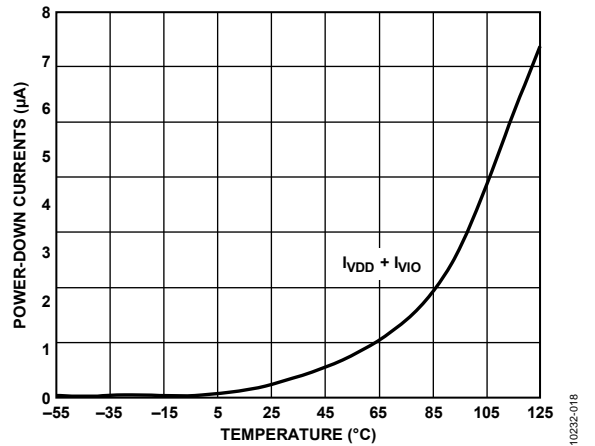


Figure 22. Power-Down Currents vs. Temperature

10232-018

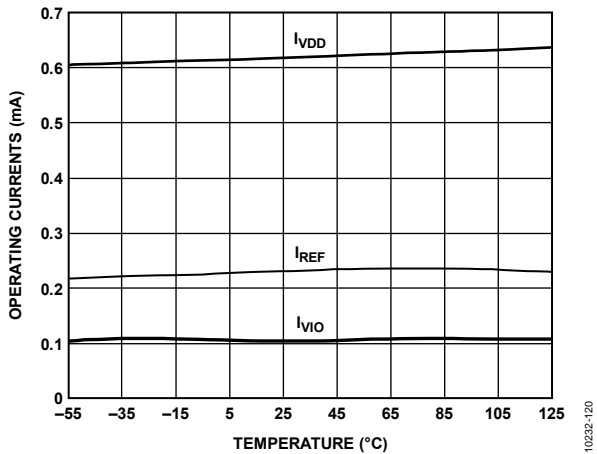


Figure 20. Operating Currents vs. Temperature (AD7989-5)

10232-120

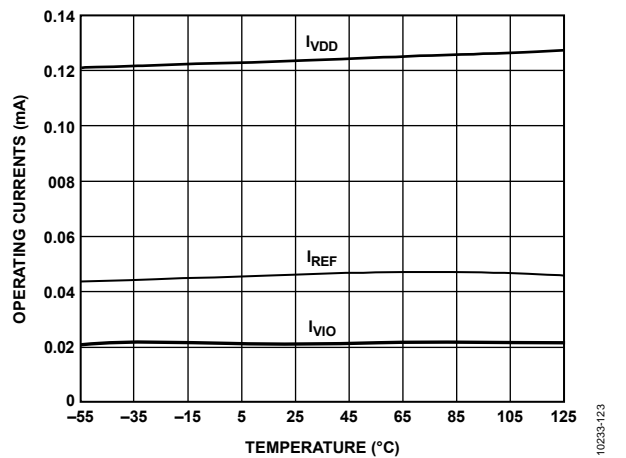


Figure 23. Operating Currents vs. Temperature (AD7989-1)

10232-123

TERMINOLOGY

Integral Nonlinearity Error (INL)

INL refers to the deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs ½ LSB before the first code transition. Positive full scale is defined as a level 1½ LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line (see Figure 25).

Differential Nonlinearity Error (DNL)

In an ideal ADC, code transitions are 1 LSB apart. DNL is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

Zero Error

Zero error is the difference between the ideal midscale voltage, that is, 0 V, and the actual voltage producing the midscale output code, that is, 0 LSB.

Gain Error

The first code transition (from 100 ... 00 to 100 ... 01) occurs at a level ½ LSB above nominal negative full scale (–4.999981 V for the ±5 V range). The last transition (from 011 ... 10 to 011 ... 11) occurs for an analog voltage 1½ LSB below the nominal full scale (+4.999943 V for the ±5 V range). The gain error is the deviation of the difference between the actual level of the last transition and the actual level of the first transition from the difference between the ideal levels.

Spurious-Free Dynamic Range (SFDR)

SFDR is the difference, in decibels, between the rms amplitude of the input signal and the peak spurious signal.

Effective Number of Bits (ENOB)

ENOB is a measurement of the resolution with a sine wave input. It is related to SINAD as follows:

$$ENOB = (SINAD_{dB} - 1.76)/6.02$$

and is expressed in bits.

Noise Free Code Resolution

Noise free code resolution is the number of bits beyond which it is impossible to distinctly resolve individual codes. It is calculated as

$$Noise\ Free\ Code\ Resolution = \log_2(2^N/Peak\text{-}to\text{-}Peak\ Noise)$$

and is expressed in bits.

Effective Resolution

Effective resolution is calculated as

$$Effective\ Resolution = \log_2(2^N/RMS\ Input\ Noise)$$

Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal and is expressed in decibels.

Dynamic Range

Dynamic range is the ratio of the rms value of the full scale to the total rms noise measured with the inputs shorted together. The value for dynamic range is expressed in decibels. It is measured with a signal at –60 dB so it includes all noise sources and DNL artifacts.

Signal-to-Noise Ratio (SNR)

SNR is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and dc. The value for SNR is expressed in decibels.

Signal-to-Noise-and-Distortion (SINAD) Ratio

SINAD is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components that are less than the Nyquist frequency, including harmonics but excluding dc. The value of SINAD is expressed in decibels.

Aperture Delay

Aperture delay is the measure of the acquisition performance and is the time between the rising edge of the CNV input and when the input signal is held for a conversion.

Transient Response

Transient response is the time required for the ADC to accurately acquire its input after a full-scale step function is applied.

THEORY OF OPERATION

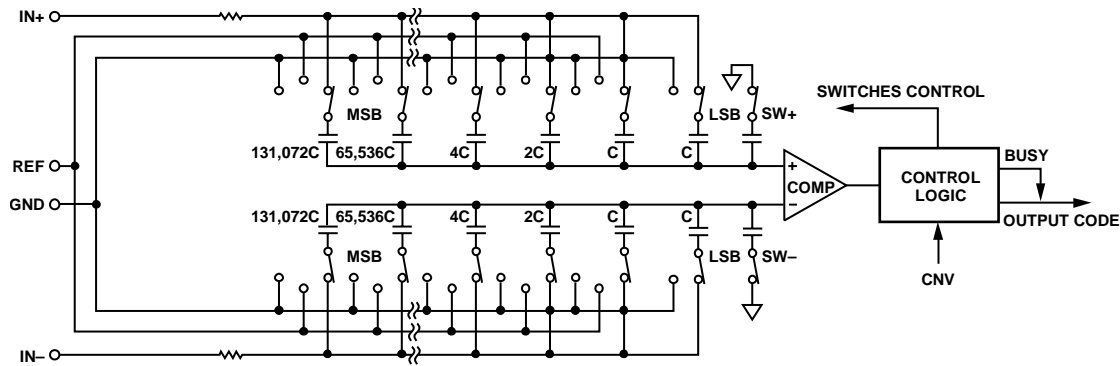


Figure 24. ADC Simplified Schematic

10232-020

CIRCUIT INFORMATION

The [AD7989-1/AD7989-5](#) are high speed, low power, single-supply, precise, 18-bit ADCs using a successive approximation architecture.

The [AD7989-1](#) is capable of converting 100,000 samples per second (100 kSPS), whereas the [AD7989-5](#) is capable of converting 500,000 samples per second (500 kSPS), and they power down between conversions. When operating at 100 kSPS, the ADC typically consumes 700 μ W, making the [AD7989-1](#) ideal for battery-powered applications.

The [AD7989-1/AD7989-5](#) provide the user with an on-chip track-and-hold amplifier and do not exhibit any pipeline delay or latency, making these devices ideal for multiple multiplexed channel applications.

The [AD7989-1/AD7989-5](#) can be interfaced to any 1.8 V to 5 V digital logic family. It is available in a 10-lead MSOP or a tiny 10 lead LFCSP that allows space savings and flexible configurations.

CONVERTER OPERATION

The [AD7989-1/AD7989-5](#) are a successive approximation ADCs based on a charge redistribution digital-to-analog converter (DAC). Figure 24 shows the simplified schematic of the ADC. The capacitive DAC consists of two identical arrays of 18 binary weighted capacitors, which are connected to the two comparator inputs.

During the acquisition phase, terminals of the array tied to the input of the comparator are connected to GND via Switch SW+ and Switch SW-. All independent switches are connected to the analog inputs. Therefore, the capacitor arrays are used as sampling capacitors and acquire the analog signal on the IN+ input and IN- input. When the acquisition phase completes and the CNV input goes high, a conversion phase initiates. When the conversion phase begins, SW+ and SW- are opened first. The two capacitor arrays then disconnect from the inputs and connect to the GND input. Therefore, the differential voltage between the IN+ and IN- inputs captured at the end of the acquisition phase is applied to the comparator inputs, causing the comparator to become unbalanced. By switching each element of the capacitor array between GND and REF, the comparator input varies by binary weighted voltage steps ($V_{REF}/2, V_{REF}/4 \dots V_{REF}/262,144$). The control logic toggles these switches, starting with the MSB, to bring the comparator back into a balanced condition. After the completion of this process, the device returns to the acquisition phase, and the control logic generates the ADC output code.

Because the [AD7989-1/AD7989-5](#) have an on-board conversion clock, the serial clock, SCK, is not required for the conversion process.

Transfer Functions

The ideal transfer characteristic for the AD7989-1/AD7989-5 is shown in Figure 25 and Table 8.

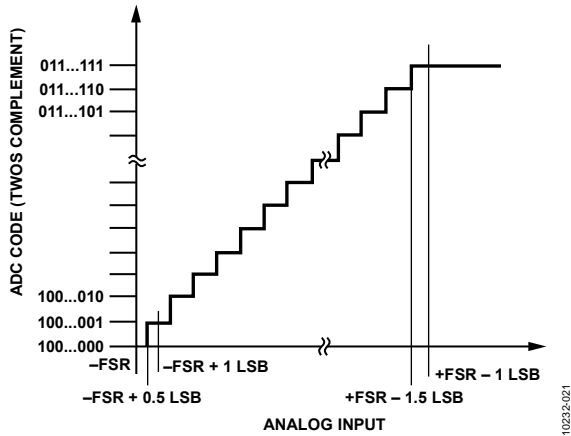


Figure 25. ADC Ideal Transfer Function

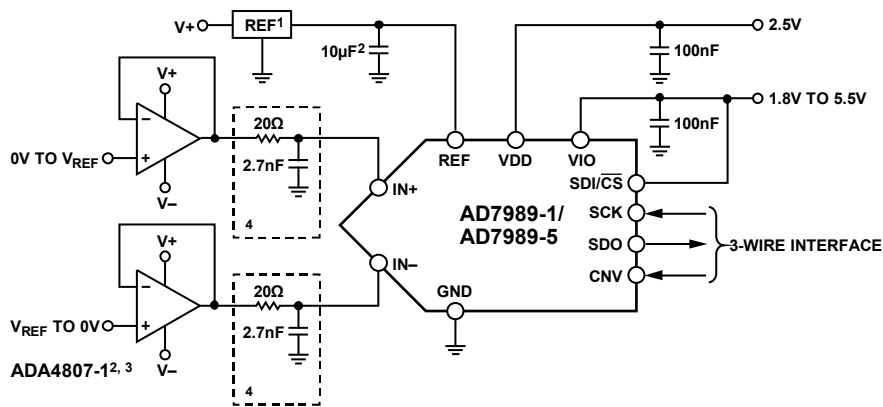
Table 8. Output Codes and Ideal Input Voltages

Description	Analog Input $V_{REF} = 5\text{ V}$	Digital Output Code (Hex)
+FSR - 1 LSB	+4.999962 V	0x1FFFF ¹
Midscale + 1 LSB	+38.15 μV	0x00001
Midscale	0 V	0x00000
Midscale - 1 LSB	-38.15 μV	0x3FFFF
-FSR + 1 LSB	-4.999962 V	0x20001
-FSR	-5 V	0x20000 ²

¹ This is also the code for an overranged analog input ($V_{IN+} - V_{IN-}$ above $V_{REF} - V_{GND}$).
² This is also the code for an underanged analog input ($V_{IN+} - V_{IN-}$ below V_{GND}).

TYPICAL CONNECTION DIAGRAM

Figure 26 shows an example of the recommended connection diagram for the AD7989-1/AD7989-5 when multiple supplies are available.



- ¹SEE THE VOLTAGE REFERENCE INPUT SECTION FOR REFERENCE SELECTION.
- ² C_{REF} IS USUALLY A 10 μF CERAMIC CAPACITOR (X5R).
SEE THE RECOMMENDED LAYOUT IN FIGURE 39 AND FIGURE 40.
- ³SEE THE DRIVER AMPLIFIER CHOICE SECTION.
- ⁴OPTIONAL FILTER. SEE THE ANALOG INPUTS SECTION.

Figure 26. Typical Application Diagram with Multiple Supplies

ANALOG INPUTS

Figure 27 shows an equivalent circuit of the input structure of the AD7989-1/AD7989-5.

The two diodes, D1 and D2, provide electrostatic discharge (ESD) protection for the IN+ analog input and IN- analog input. Ensure the analog input signal does not exceed the reference input voltage (REF) by more than 0.3 V. If the analog input signal exceeds this level, the diodes become forward-biased and begin conducting current. These diodes can handle a forward-biased current of 130 mA maximum. However, if the supplies of the input buffer (for example, the supplies of the ADA4807-1 in Figure 26) are different from those of REF, the analog input signal can eventually exceed the supply rails by more than 0.3 V. In such a case (for example, an input buffer with a short circuit), the current limitation can protect the device.

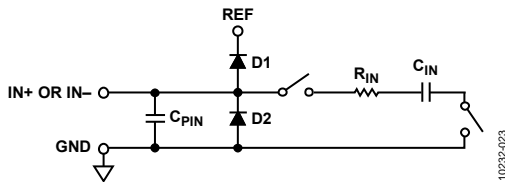


Figure 27. Equivalent Analog Input Circuit

The analog input structure allows the sampling of the true differential signal between IN+ and IN-. By using these differential inputs, signals common to both inputs are rejected.

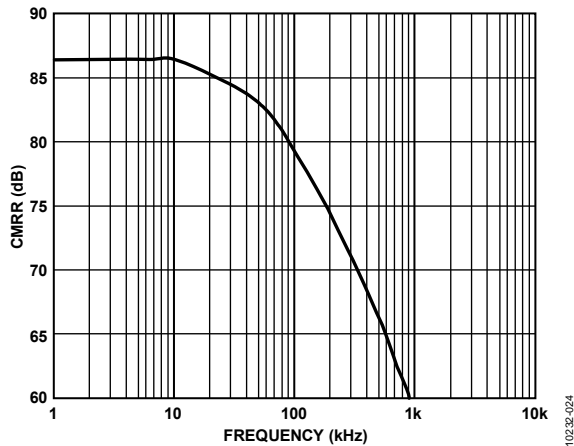


Figure 28. Analog Input CMRR vs. Frequency

During the acquisition phase, the impedance of the analog inputs (IN+ or IN-) can be modeled as a parallel combination of Capacitor C_{PIN} and the network formed by the series connection of R_{IN} and C_{IN}. C_{PIN} is primarily the pin capacitance. R_{IN} is typically 400 Ω and is a lumped component composed of serial resistors and the on resistance of the switches. C_{IN} is typically 30 pF and is mainly the ADC sampling capacitor.

During the sampling phase when the switches are closed, the input impedance is limited to C_{PIN}. R_{IN} and C_{IN} make a one-pole, low-pass filter that reduces undesirable aliasing effects and limits noise.

When the source impedance of the driving circuit is low, the AD7989-1/AD7989-5 can be driven directly.

Large source impedances significantly affect the ac performance, especially THD. The dc performances are less sensitive to the input impedance. The maximum source impedance depends on the amount of THD that can be tolerated. The THD degrades as a function of the source impedance and the maximum input frequency.

DRIVER AMPLIFIER CHOICE

Although the AD7989-1/AD7989-5 is easy to drive, the driver amplifier must meet the following requirements:

- The noise generated by the driver amplifier must be kept as low as possible to preserve the SNR and transition noise performance of the AD7989-1/AD7989-5. The noise from the driver is filtered by the one-pole, low-pass filter of the AD7989-1/AD7989-5 analog input circuit made by R_{IN} and C_{IN} or by the external filter, if one is used. Because the typical noise of the AD7989-1/AD7989-5 is 40 μV rms, the SNR degradation due to the amplifier is

$$SNR_{LOSS} = 20 \log \left(\frac{40}{\sqrt{40^2 + \frac{\pi}{2} f_{-3dB} (Ne_N)^2}} \right)$$

- where:
 - f_{-3dB} is the input bandwidth, in megahertz, of the AD7989-1/AD7989-5 (10 MHz) or the cutoff frequency of the input filter, if one is used.
 - N is the noise gain of the amplifier (for example, 1 in buffer configuration).
 - e_N is the equivalent input noise voltage of the op amp in nV/√Hz.
- For ac applications, use a driver with a THD performance commensurate with the AD7989-1/AD7989-5.
- For multichannel, multiplexed applications, the driver amplifier and the AD7989-1/AD7989-5 analog input circuit must settle for a full-scale step onto the capacitor array at an 18-bit level (0.0004%, 4 ppm). In the data sheet of the amplifier, settling at 0.1% to 0.01% is more commonly specified. This settling can differ significantly from the settling time at an 18-bit level and must be verified prior to driver selection.

Table 9. Recommended Driver Amplifiers¹

Amplifier	Typical Application
ADA4941-1	Very low noise, low power, single to differential
ADA4940-1	Very low noise, low power, single to differential
ADA4807-2	Very low noise and low power
ADA4627-1	Precision, low noise and low input bias
ADA4522-2	Precision, zero drift and electromagnetic interference (EMI) enhanced
ADA4500-2	Precision, rail-to-rail input and output (RRIO) and zero input crossover distortion

¹ For the latest recommended drivers, see the product recommendations listed on the product webpage.

SINGLE-ENDED TO DIFFERENTIAL DRIVER

For applications using a single-ended analog signal, either bipolar or unipolar, the [ADA4941-1](#) single-ended to differential driver allows a differential input to the device. The schematic is shown in Figure 29.

R1 and R2 set the attenuation ratio between the input range and the ADC voltage range (V_{REF}). R1, R2, and C_F are chosen depending on the desired input resistance, signal bandwidth, antialiasing, and noise contribution. For example, for the ± 10 V range with a 4 k Ω impedance, R2 = 1 k Ω and R1 = 4 k Ω .

R3 and R4 set the common mode on the IN $-$ input, and R5 and R6 set the common mode on the IN $+$ input of the ADC. Ensure the common mode is close to $V_{REF}/2$. For example, for the ± 10 V range with a single supply, R3 = 8.45 k Ω , R4 = 11.8 k Ω , R5 = 10.5 k Ω , and R6 = 9.76 k Ω .

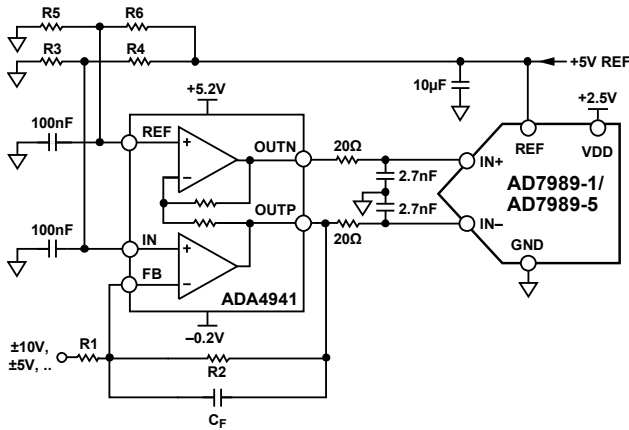


Figure 29. Single-Ended to Differential Driver Circuit

VOLTAGE REFERENCE INPUT

The [AD7989-1/AD7989-5](#) voltage reference input, REF, has a dynamic input impedance and must, therefore, be driven by a low impedance source with efficient decoupling between the REF and GND pins, as explained in the Layout section.

When REF is driven by a very low impedance source (for example, a reference buffer using the [AD8031](#) or the [ADA4807-1](#)), a 10 μ F (X5R, 0805 size) ceramic chip capacitor is appropriate for optimum performance.

If using an unbuffered reference voltage, the decoupling value depends on the reference used. For instance, a 22 μ F (X5R, 1206 size) ceramic chip capacitor is appropriate for optimum performance using a low temperature drift [ADR435](#) reference.

If desired, use a reference decoupling capacitor with values as small as 2.2 μ F with a minimal impact on performance, especially DNL.

Regardless, there is no need for an additional lower value ceramic decoupling capacitor (for example, 100 nF) between the REF and GND pins.

POWER SUPPLY

The [AD7989-1/AD7989-5](#) use two power supply pins: a core supply (VDD) and a digital input/output interface supply (VIO). VIO allows direct interface with any logic between 1.8 V and 5.5 V. To reduce the number of supplies needed, tie VIO and VDD together. The [AD7989-1/AD7989-5](#) are independent of power supply sequencing between VIO and VDD. Additionally, they are insensitive to power supply variations over a wide frequency range, as shown in Figure 30.

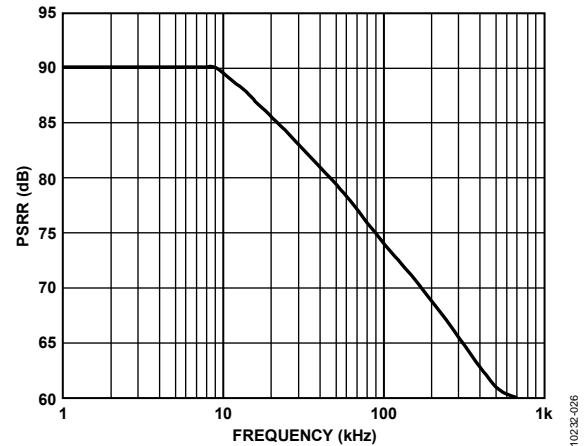


Figure 30. PSRR vs. Frequency

The [AD7989-1/AD7989-5](#) power down automatically at the end of each conversion phase.

DIGITAL INTERFACE

Although the [AD7989-1/AD7989-5](#) have a reduced number of pins, they offer flexibility in their serial interface modes.

When in \overline{CS} mode, the [AD7989-1/AD7989-5](#) are compatible with SPI, queued serial peripheral interface (QSPI), digital hosts, and digital signal processors (DSPs). In this mode, the [AD7989-1/AD7989-5](#) can use either a 3-wire or 4-wire interface. A 3-wire interface using the CNV, SCK, and SDO signals minimizes wiring connections, which is useful, for instance, in isolated applications. A 4-wire interface using the SDI/ \overline{CS} , CNV, SCK, and SDO signals allows CNV, which initiates the conversions, to be independent of the readback timing (SDI). This is useful in low jitter sampling or simultaneous sampling applications.

When in chain mode, the [AD7989-1/AD7989-5](#) provide a daisy-chain feature using the SDI input for cascading multiple ADCs on a single data line, similar to a shift register.

The mode in which the device operates depends on the SDI/ \overline{CS} level when the CNV rising edge occurs. \overline{CS} mode is selected if SDI/ \overline{CS} is high, and chain mode is selected if SDI/ \overline{CS} is low. The SDI/ \overline{CS} hold time is such that when SDI/ \overline{CS} and CNV are connected together, chain mode is always selected. The user must timeout the maximum conversion time prior to readback.

\overline{CS} MODE, 3-WIRE

This mode is usually used when a single AD7989-1/AD7989-5 is connected to an SPI-compatible digital host. The connection diagram is shown in Figure 31, and the corresponding timing is given in Figure 32.

With SDI/ \overline{CS} tied to VIO, a rising edge on CNV initiates a conversion, selects the \overline{CS} mode, and forces SDO to high impedance.

When the conversion is complete, the AD7989-1/AD7989-5 enter the acquisition phase and power down. When CNV goes low, the MSB is output onto SDO. The remaining data bits are clocked by subsequent SCK falling edges. The data is valid on both SCK edges. Although the rising edge can capture the data, a digital host using the SCK falling edge allows a faster reading rate, provided that it has an acceptable hold time. After the 18th SCK falling edge or when CNV goes high (whichever occurs first), SDO returns to high impedance.

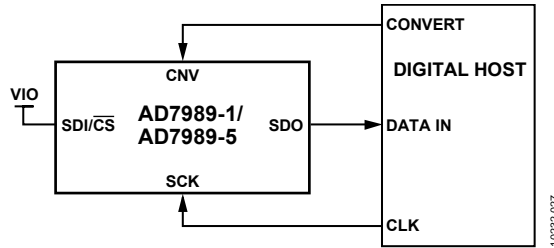


Figure 31. \overline{CS} Mode, 3-Wire Connection Diagram (SDI High)

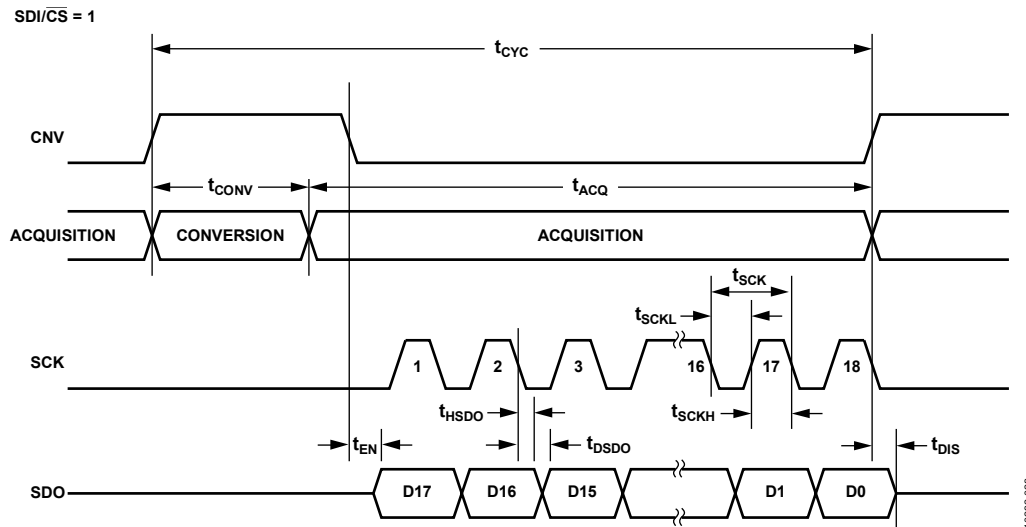


Figure 32. \overline{CS} Mode, 3-Wire Serial Interface Timing (SDI High)

CS MODE, 4-WIRE

This mode is usually used when multiple AD7989-1/AD7989-5 devices are connected to an SPI-compatible digital host.

A connection diagram example using two AD7989-1/AD7989-5 devices is shown in Figure 33, and the corresponding timing is given in Figure 34.

With SDI high, a rising edge on CNV initiates a conversion, selects SDI/CS mode, and forces SDO to high impedance. In this mode, CNV must be held high during the conversion phase and the subsequent data readback. If SDI/CS and CNV are low, SDO is driven low.

Prior to the minimum conversion time, SDI/CS can select other SPI devices, such as analog multiplexers, but SDI/CS must be returned high before the minimum conversion time elapses and then held high for the maximum possible conversion time.

When the conversion is complete, the AD7989-1/AD7989-5 enter the acquisition phase and power down. Each ADC result can be read by bringing its SDI/CS input low, which consequently outputs the MSB onto SDO. The remaining data bits are then clocked by subsequent SCK falling edges. The data is valid on both SCK edges. Although the rising edge can capture the data, a digital host using the SCK falling edge allows a faster reading rate, provided it has an acceptable hold time. After the 18th SCK falling edge or when SDI/CS goes high (whichever occurs first), SDO returns to high impedance and another AD7989-1/AD7989-5 can be read.

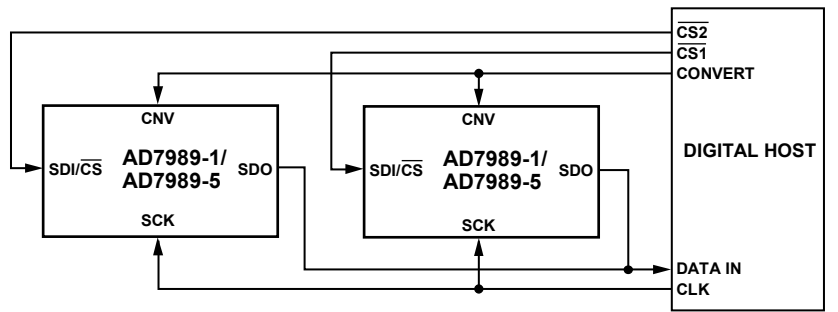


Figure 33. CS Mode, 4-Wire Connection Diagram

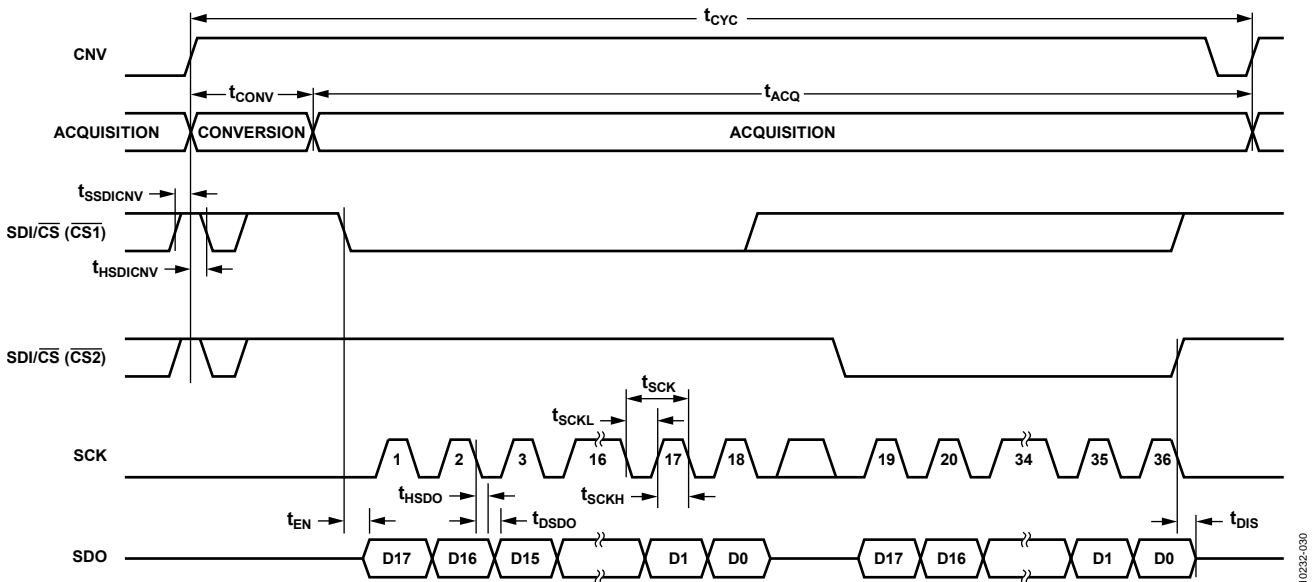


Figure 34. CS Mode, 4-Wire Serial Interface Timing

CHAIN MODE

This mode can daisy-chain multiple AD7989-1/AD7989-5 devices on a 3-wire serial interface. This feature reduces component count and wiring connections, for example, in isolated multiconverter applications or for systems with a limited interfacing capacity. Data readback is analogous to clocking a shift register.

A connection diagram example using two AD7989-1/AD7989-5 devices is shown in Figure 35, and the corresponding timing is given in Figure 36.

When $\overline{\text{SDI/CS}}$ and CNV are low, SDO is driven low. With SCK low, a rising edge on CNV initiates a conversion, and selects the chain mode.

In this mode, CNV is held high during the conversion phase and the subsequent data readback. When the conversion is complete, the MSB is output onto SDO and the AD7989-1/AD7989-5 enter the acquisition phase and power down. The remaining data bits stored in the internal shift register are clocked by subsequent SCK falling edges. For each ADC, SDI feeds the input of the internal shift register and is clocked by the SCK falling edge. Each ADC in the chain outputs its data MSB first, and $18 \times N$ clocks are required to read back the N ADCs. The data is valid on both SCK edges. Although the rising edge can capture the data, a digital host using the SCK falling edge allows a faster reading rate and, consequently, more AD7989-1/AD7989-5 devices in the chain, provided that the digital host has an acceptable hold time. The maximum conversion rate may be reduced due to the total readback time.

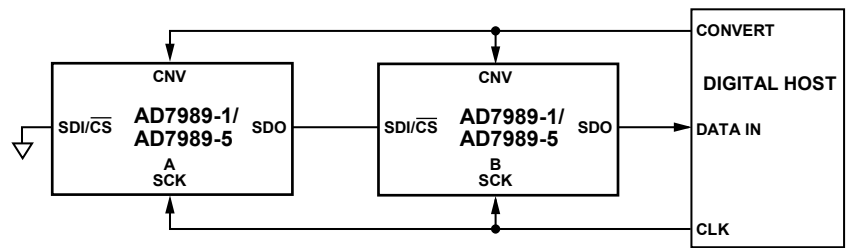


Figure 35. Chain Mode Connection Diagram

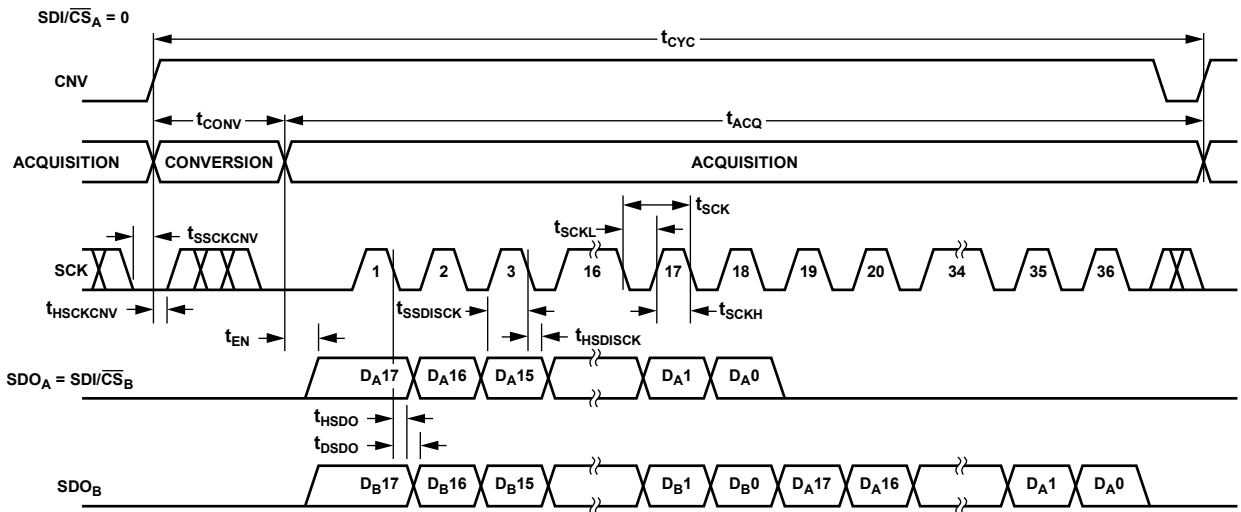


Figure 36. Chain Mode Serial Interface Timing

APPLICATIONS INFORMATION

INTERFACING TO BLACKFIN® DSP

The AD7989-1/AD7989-5 can easily connect to a DSP, SPI, or SPORT. The SPI configuration is straightforward using the standard SPI interface, as shown in Figure 37.

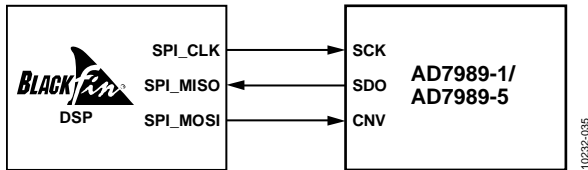


Figure 37. Typical Connection to Blackfin SPI Interface

Similarly, the SPORT interface can interface to this ADC. The SPORT interface has some benefits in that it can use direct memory access (DMA) and provides a lower jitter CNV signal generated from a hardware counter.

Some glue logic may be required between SPORT and the AD7989-1/AD7989-5 interface. The EVAL-AD7989-5SDZ evaluation board for the AD7989-1/AD7989-5 interfaces directly to the SPORT of the Blackfin-based (ADSP-BF527) SDP board. The configuration used for the SPORT interface requires the addition of some glue logic as shown in Figure 38. The SCK input to the ADC was gated off when CNV was high to keep the SCK line static while converting the data, thereby ensuring the best integrity of the result. This approach uses an AND gate and a NOT gate for the SCK path. The other logic gates used on the RSCLK and RFS paths are for delay matching purposes and may not be necessary when path lengths are short.

This is one approach to using the SPORT interface for the AD7989-1/AD7989-5 ADC; there can be other solutions similar to this approach.

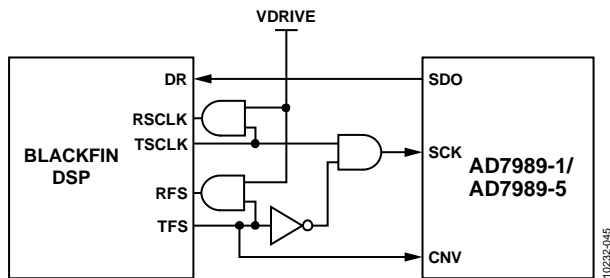


Figure 38. The EVAL-AD7989-5SDZ Evaluation Board Connection to Blackfin SPORT Interface

LAYOUT

The printed circuit board (PCB) that houses the AD7989-1/AD7989-5 must be designed so the analog and digital sections are separated and confined to certain areas of the PCB. The pinout of the AD7989-1/AD7989-5, with its analog signals on the left side and its digital signals on the right side, eases this task.

Avoid running digital lines under the device because these couple noise onto the die, unless a ground plane under the AD7989-1/AD7989-5 is used as a shield. Do not run fast switching signals, such as CNV or clocks, near analog signal paths. Avoid crossover of digital and analog signals.

Using at least one ground plane is recommended. It can be common or split between the digital and analog sections. In the latter case, join the planes underneath the AD7989-1/AD7989-5 devices.

The AD7989-1/AD7989-5 voltage reference input, REF, has a dynamic input impedance. Decouple REF with minimal parasitic inductances by placing the reference decoupling ceramic capacitor close to, but ideally right up against, the REF and GND pins and connecting them with wide, low impedance traces.

Finally, decouple the power supplies of the AD7989-1/AD7989-5, VDD and VIO, with ceramic capacitors, typically 100 nF, placed close to the AD7989-1/AD7989-5 and connected using short, wide traces to provide low impedance paths and to reduce the effect of glitches on the power supply lines.

An example of a layout following these rules is shown in Figure 39 and Figure 40.

EVALUATING AD7989-1/AD7989-5 PERFORMANCE

Other recommended layouts for the AD7989-1/AD7989-5 are outlined in UG-340 user guide for the EVAL-AD7989-5SDZ. The evaluation board package includes a fully assembled and tested evaluation board, the user guide, and software for controlling the evaluation board from a PC via the EVAL-SDP-CB1Z.

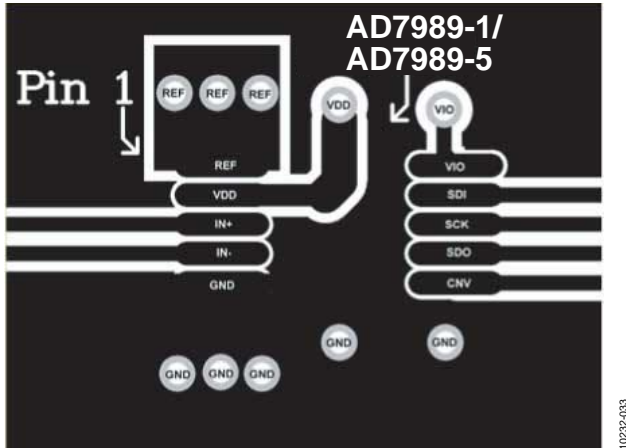


Figure 39. Recommended Layout of the AD7989-1/AD7989-5 (Top Layer)

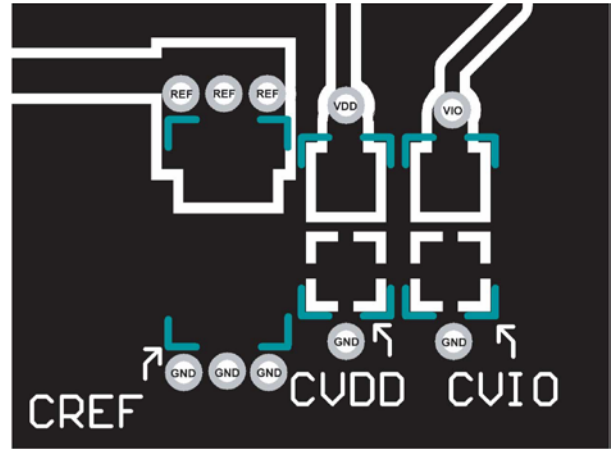
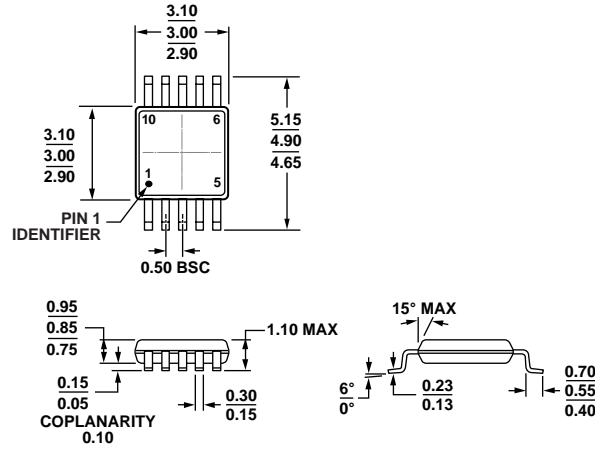


Figure 40. Recommended Layout of the AD7989-1/AD7989-5 (Bottom Layer)

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-187-BA

Figure 41. 10-Lead Mini Small Outline Package [MSOP] (RM-10)

Dimensions shown in millimeters

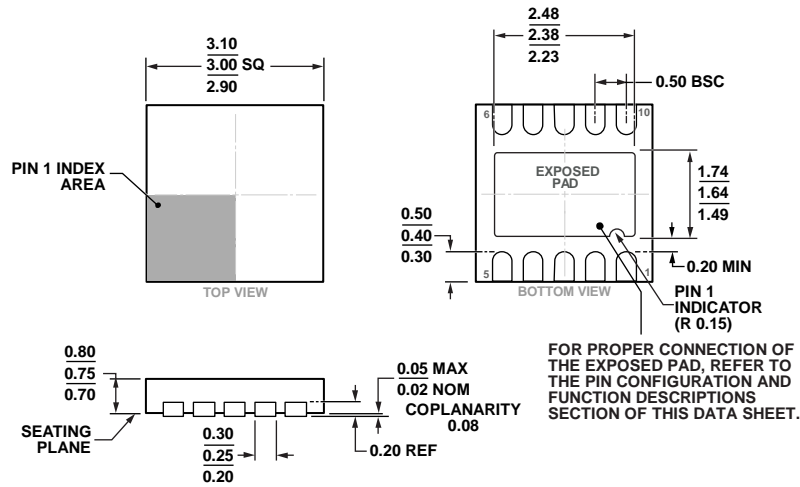


Figure 42. 10-Lead Lead Frame Chip Scale Package [LFCSP] 3 mm x 3 mm Body, Very Very Thin, Dual Lead (CP-10-9)

Dimensions shown in millimeters

ORDERING GUIDE

Model ^{1, 2, 3}	Temperature Range	Package Description	Package Option	Branding	Ordering Quantity
AD7989-1BRMZ	−40°C to +85°C	10-Lead MSOP, Tube	RM-10	C76	50
AD7989-1BRMZ-RL7	−40°C to +85°C	10-Lead MSOP, 7" Tape and Reel	RM-10	C76	1,000
AD7989-1BCPZ-RL7	−40°C to +85°C	10-Lead LFCSP, 7" Tape and Reel	CP-10-9	C80	1,500
AD7989-1BCPZ-R2	−40°C to +85°C	10-Lead LFCSP	CP-10-9	C80	250
AD7989-5BRMZ	−40°C to +85°C	10-Lead MSOP, Tube	RM-10	C7N	50
AD7989-5BRMZ-RL7	−40°C to +85°C	10-Lead MSOP, 7" Tape and Reel	RM-10	C7N	1,000
AD7989-5BCPZ-RL7	−40°C to +85°C	10-Lead LFCSP, 7" Tape and Reel	CP-10-9	C7Y	1,500
AD7989-5BCPZ-R2	−40°C to +85°C	10-Lead LFCSP	CP-10-9	C7Y	250
EVAL-AD7989-5SDZ		Evaluation Board with AD7989-5 Populated; Use for Evaluation of Both AD7989-1 and AD7989-5			
EVAL-SDP-CB1Z		System Demonstration Board, Used as a Controller Board for Data Transfer via USB Interface to PC			

¹ Z = RoHS Compliant Part.

² The [EVAL-AD7989-5SDZ](#) board can be used as a standalone evaluation board or in conjunction with the [EVAL-SDP-CB1Z](#) for evaluation/demonstration purposes.

³ The [EVAL-SDP-CB1Z](#) board allows a PC to control and communicate with all Analog Devices, Inc., evaluation boards ending in the SD designator.

NOTES

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